

# Polyaniline Nanofiber Based Inks for Security Printing Applications Connor Holland: SWOSU

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## Background

Polyaniline is a common organic conducting polymer. Recently, polyaniline nanofibers have attracted a great deal of attention due to some of their unique properties. Polyanilne nanofibers are currently being used in sensors, memory devices, actuators, etc. This research project investigates polyaniline nanofiber based inks and how the unique properties of polyaniline could be applied to security printing and anticounterfeiting technology.

# **Objective**

- · Synthesize uniform polyaniline nanofibers and characterize morphology
- Use direct write printing technology to pattern stencils using polyaniline based inks
- Investigate difference in conductivity of flash welded regions and non flash welded regions

# **Experimental Procedure**

Polyaniline nanofibers were synthesized using interfacial polymerization. Aniline was added to an organic phase, i.e. chloroform. Ammonium persulfate was dissolved into an aqueous phase of hydrochloric acid. The molar ratio of aniline to ammonium persulfate was kept at 4:1 respectively. After letting the reactants interact fully cleaning was accomplished by using methanol and centrifuging.



Polyaniline nanofiber based inks were printed using direct write printing technology. This was accomplished using a Hewlett Packard thermal inkjet pipette system (TIPS) printer. Varied weight percent inks were printed onto paper, kapton, and glass substrates. Different numbers of passes and speed of passes by the TIPS printer were tested in order to print uniform patterns.

Flash welding was accomplished using a camera flash from a couple inches away and also by using a 635 nanometer laser. The conductivity of flash welded portions was then compared to conductivity of nonflash welded regions. The substrates flash welding was accomplished on were also varied.



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# **Results**

### **Synthesis**



• Diameter of 60-90 nanometers • Length of 700-900 nanometers disperse longer and more fully in

SEM image showing successful synthesis of polyaniline nanofibers

### Printing

water



Uniform stencils printed on a) Kapton B) Paper and c) Glass

- · Approximate thickness of 9 micrometers
- · Thickness allows conductivity to be found



0.5



PAN ED



SEM images showing difference before and after flash welding

Flash welding accomplished using a 635 nm laser

• Difference between flash welded and non-flash welded portions s is apparen

Flash Welding

- Laser flash welding allows for patterns to be etched
- Non-flash welded regions are conductive, approximately 200 S/m
- Flash welded regions are non-conductive



Graph showing difference in conductivity of flash welded regions and non-flash welded regions

# **Conclusions**

- · Polyaniline nanofibers can be uniformly synthesized with relative ease
- Direct write printing of polyaniline based inks is possible
- Flash welding causes a physical change in polyaniline that could prove useful in security printing applications

# Acknowledgments

References: Henderson, R., Breadmore, M., Dennany, L., Guijt, R., Haddad, P., Hilder, E., Innis, P., Lewis, T., Wallace, G. (n.d.). Photolithographic patterning of conductin polyanilme films via fash welding. Synthetic Metals, 1405-1409; Strong, V., Wang, Y., Pattanayan, A., Whitten, P., Spinis, G., Wallace, G., & Kane, R. (2011). Direct Su Micrometer Patterning of Nanostructured Conducting Polymer Films via a Low-Energy Infared Laser. Nano Letter, 3128-300.

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SEM image showing uniform thickness after printing

- ranging from 5 to 25
- 1, 2, and 5 weight percent inks

were all printed succesfully



• Several number of passes tested Stencils came out best when hot

plate below was held at 60°C